

3.0X1.5mm INFRARED EMITTING DIODE

Part Number: APL3015F3C-F01

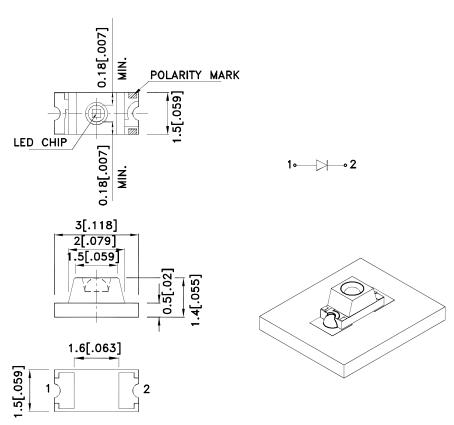
Features

- 3.0mmx1.5mm SMT LED, 1.4mm thickness.
- Mechanically and spectrally matched to the phototransistor.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
APL3015F3C-F01	F3 (GaAs)	Water Clear	1.2	3	- 70°
			*0.8	*2.3	

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Radiant Intensity/ luminous flux: +/-15%.

 * Radiant intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions
Forward Voltage [1]	F3	VF	1.2	1.6	V	IF=20mA
Reverse Current	F3	lR		10	uA	V _R = 5V
Capacitance	F3	С	90		pF	VF=0V;f=1MHz
Peak Spectral Wavelength	F3	λP	940		nm	IF=20mA
Spectral Bandwidth	F3	Δλ1/2	50		nm	IF=20mA

Note:

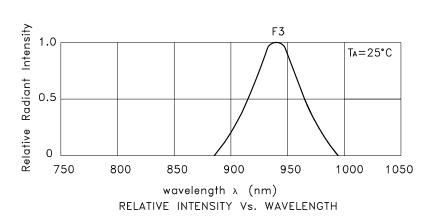
- 1. Forward Voltage: +/-0.1V.
 2. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

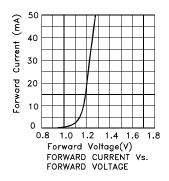
Absolute maximum Natings at 1A 20 0						
Parameter	Symbol	F3	Units			
Power dissipation	Po	80	mW			
DC Forward Current	lF	50	mA			
Peak Forward Current [1]	iFS	1.2	А			
Reverse Voltage	VR	5	V			
Operating Temperature	ТА	-40 To +85	°C			
Storage Temperature	Тѕтс	-40 To +85	°C			

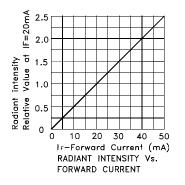
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.

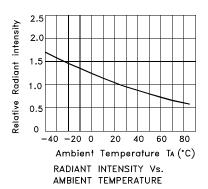
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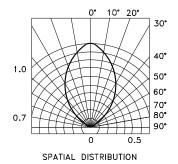


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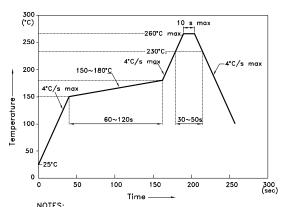
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

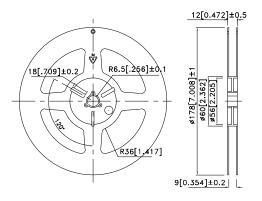
2.Don't cause stress to the epoxy resin while it is exposed to the temperature. to high temperature.

3.Number of reflow process shall be 2 times or less.

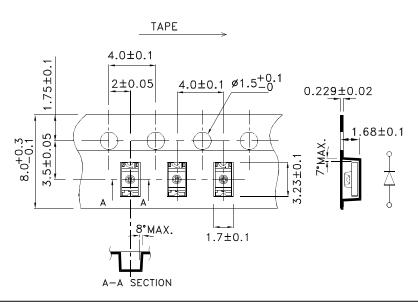
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

4.4 1.6

Reel Dimension



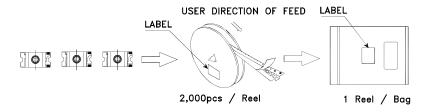
Tape Specifications (Units: mm)

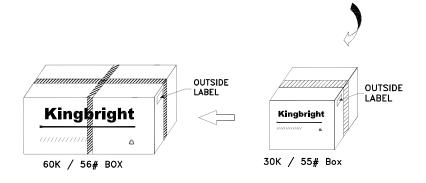


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PACKING & LABEL SPECIFICATIONS

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